

FH8810BT6

N-Channel Enhancement Mode Power MOSFET

Descriptions

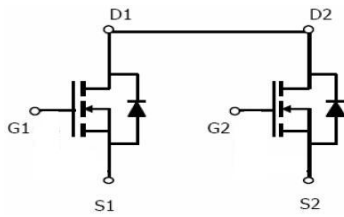
The FH8810BT6 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product FH8810BT6 is Pb-free.

Applications

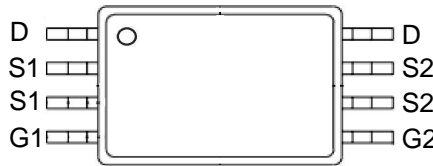
- DC-DC converter circuit
- Power Switch

Product Summary

| V_{DS} (V) | Typical $R_{DS(on)}$ (m Ω) |
|--------------|------------------------------------|
| 20 | 15 @ $V_{GS}=4.5V$ |
| | 16 @ $V_{GS}=3.8V$ |
| | 17.5 @ $V_{GS}=3.1V$ |
| | 19 @ $V_{GS}=2.5V$ |



Schematic diagram



Marking and pin Assignment



TSSOP-8 top view

Absolute Maximum ratings

| Parameter | Symbol | 10 S | Steady State | Unit | |
|------------------------------------------|-----------|------------------|--------------|------------|---|
| Drain-Source Voltage | V_{DS} | 20 | | V | |
| Gate-Source Voltage | V_{GS} | ± 10 | | | |
| Continuous Drain Current ^{a,d} | I_D | $T_A=25^\circ C$ | 6.3 | 5.7 | A |
| | | $T_A=70^\circ C$ | 5.0 | 4.6 | |
| Maximum Power Dissipation ^{a,d} | P_D | $T_A=25^\circ C$ | 1.5 | 1 | W |
| | | $T_A=70^\circ C$ | 0.9 | 0.7 | |
| Continuous Drain Current ^b | I_D | $T_A=25^\circ C$ | 5.8 | 5.2 | A |
| | | $T_A=70^\circ C$ | 4.6 | 4.1 | |
| Maximum Power Dissipation ^b | P_D | $T_A=25^\circ C$ | 0.9 | 0.7 | W |
| | | $T_A=70^\circ C$ | 0.6 | 0.5 | |
| Pulsed Drain Current ^c | I_{DM} | 30 | | A | |
| Operating Junction Temperature | T_J | -55 to 150 | | $^\circ C$ | |
| Lead Temperature | T_L | 260 | | $^\circ C$ | |
| Storage Temperature Range | T_{stg} | -55 to 150 | | $^\circ C$ | |

Thermal resistance ratings

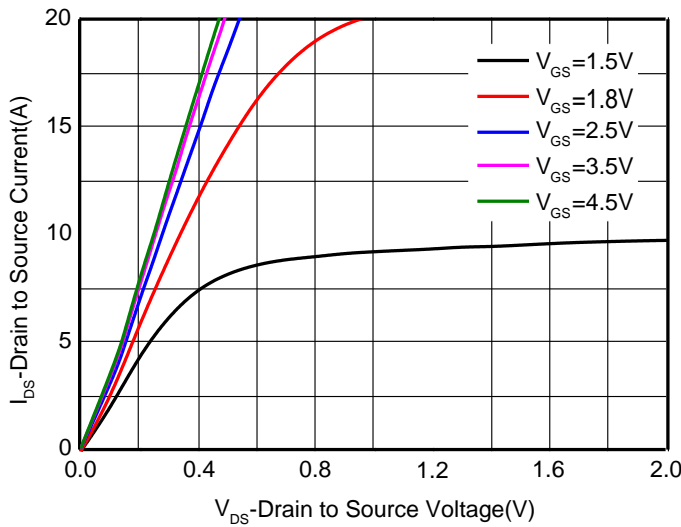
| Single Operation | | | | | |
|-----------------------------------------------------|--------------|------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Junction-to-Ambient Thermal Resistance ^a | t ≤ 10 s | R _{θJA} | 76 | 94 | °C/W |
| | Steady State | | 115 | 145 | |
| Junction to Ambient Thermal Resistance ^b | t ≤ 10 s | R _{θJA} | 92 | 115 | |
| | Steady State | | 135 | 175 | |
| Junction-to-Case Thermal Resistance | Steady State | R _{θJC} | 63 | 78 | |
| Dual Operation | | | | | |
| Junction to Ambient Thermal Resistance ^a | t ≤ 10 s | R _{θJA} | 79 | 97 | °C/W |
| | Steady State | | 118 | 148 | |
| Junction-to-Ambient Thermal Resistance ^b | t ≤ 10 s | R _{θJA} | 96 | 118 | |
| | Steady State | | 138 | 180 | |
| Junction-to-Case Thermal Resistance | Steady State | R _{θJC} | 66 | 81 | |

- a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper
- b Surface mounted on FR-4 board using minimum pad size, 1oz copper
- c Pulse width < 380μs, Duty Cycle < 2%
- d Maximum junction temperature T_J = 150°C.

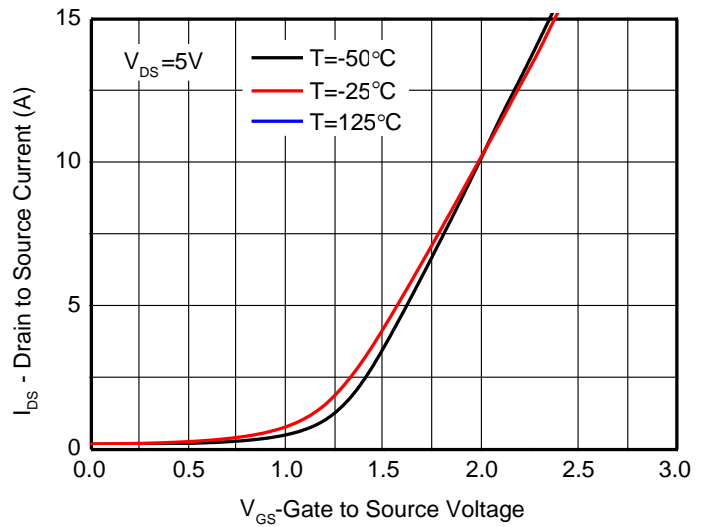
Electronics Characteristics (Ta=25°C, unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|--------------------------------------------------|---------------------|-----------------------------------------------------------------------------------------------|------|------|------|------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-to-Source Breakdown Voltage | BV _{DSS} | V _{GS} = 0 V, I _D = 250uA | 20 | | | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 16 V, V _{GS} = 0V | | | 1 | uA |
| Gate-to-source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = ±10V | | | ±100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | V _{GS} = V _{DS} , I _D = 250uA | 0.45 | 0.7 | 1.0 | V |
| Drain to source On resistance ^{b, c} | R _{DS(on)} | V _{GS} = 4.5V, I _D = 4 A | 12 | 15 | 18 | mΩ |
| | | V _{GS} = 3.8V, I _D = 4 A | 13 | 16 | 19 | |
| | | V _{GS} = 3.1V, I _D = 4 A | 14 | 17.5 | 21 | |
| | | V _{GS} = 2.5V, I _D = 2.5A | 15 | 19 | 23 | |
| Forward Transconductance | g _{FS} | V _{DS} = 5.0 V, I _D = 6.3A | | 16 | | S |
| CHARGES, CAPACITANCES AND GATE RESISTANCE | | | | | | |
| Input Capacitance | C _{ISS} | V _{GS} = 0 V, f = 1MHz, V _{DS} = 10 V | | 850 | | pF |
| Output Capacitance | C _{OSS} | | | 127 | | |
| Reverse Transfer Capacitance | C _{RSS} | | | 115 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 4.5 V, V _{DD} = 10 V, I _D = 6.3 A | | 10.9 | | nC |
| Threshold Gate Charge | Q _{G(TH)} | | | 0.62 | | |
| Gate-to-Source Charge | Q _{GS} | | | 1.92 | | |
| Gate to Drain Charge | Q _{GD} | | | 2.0 | | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Delay Time | td(ON) | V _{GS} = 4.5 V, V _{DD} = 10 V, R _L = 2Ω, R _G = 6 Ω | | 22 | | ns |
| Rise Time | tr | | | 18 | | |
| Turn Off Delay Time | td(OFF) | | | 62 | | |
| Fall Time | tf | | | 28 | | |
| BODY DIODE CHARACTERISTICS | | | | | | |
| Forward Voltage | V _{SD} | V _{GS} = 0 V, I _S = 1.0A | | 0.65 | 1.2 | V |

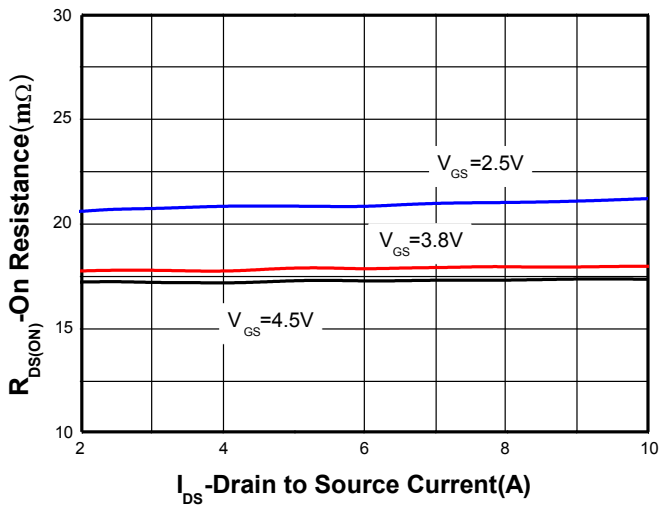
Typical Characteristics (Ta=25°C, unless otherwise noted)



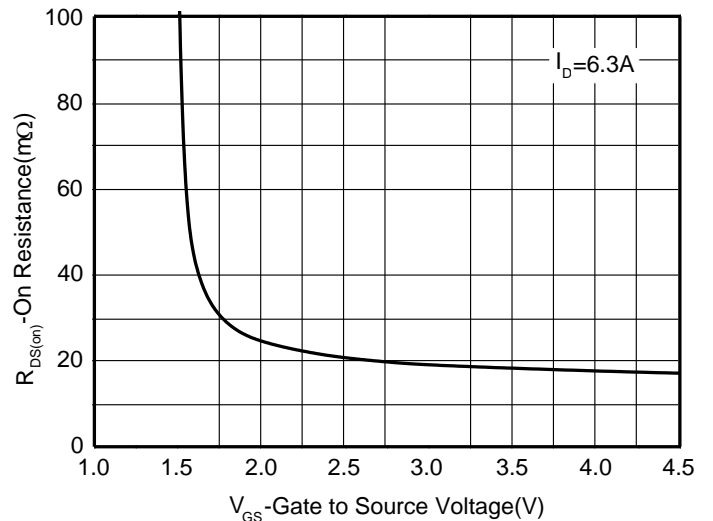
Output characteristics



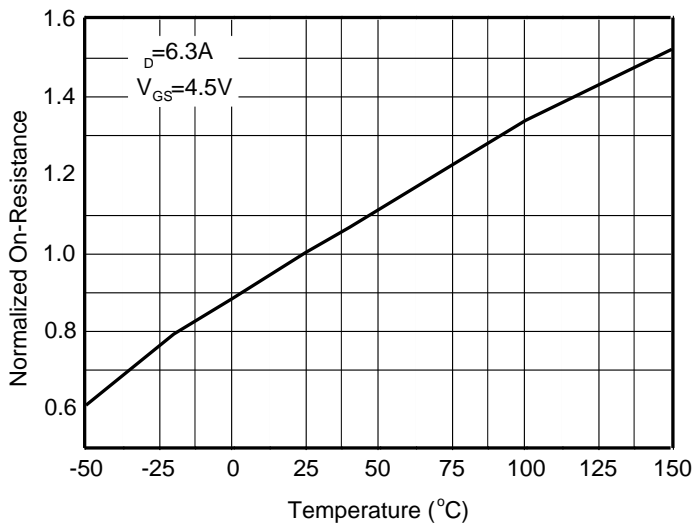
Transfer characteristics



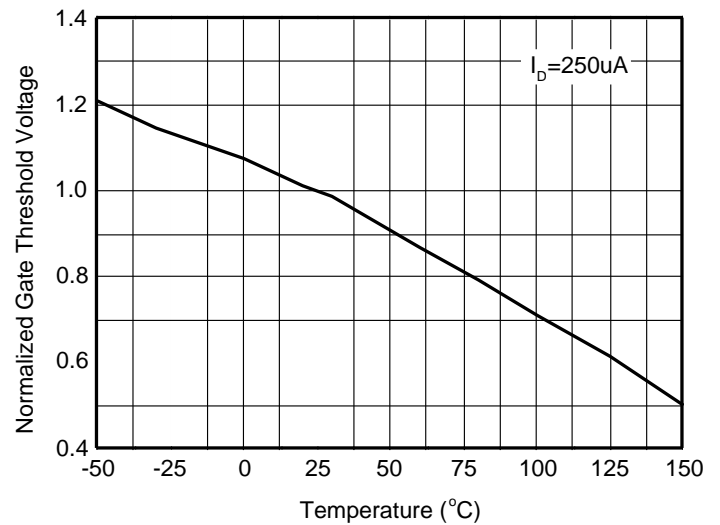
On-Resistance vs. Drain current



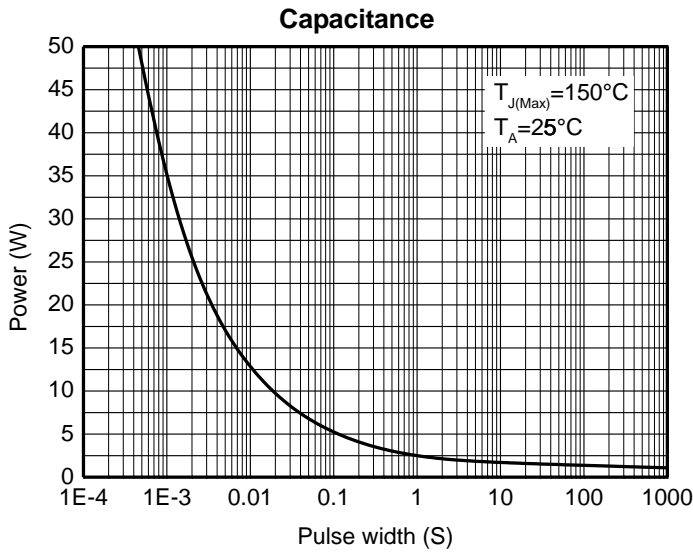
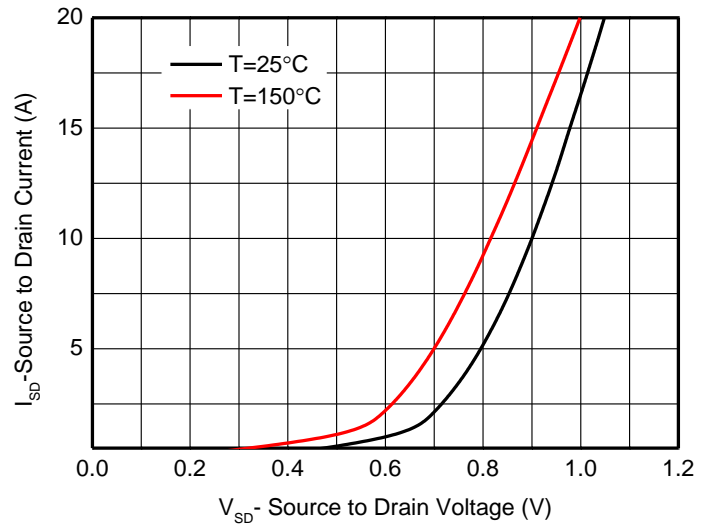
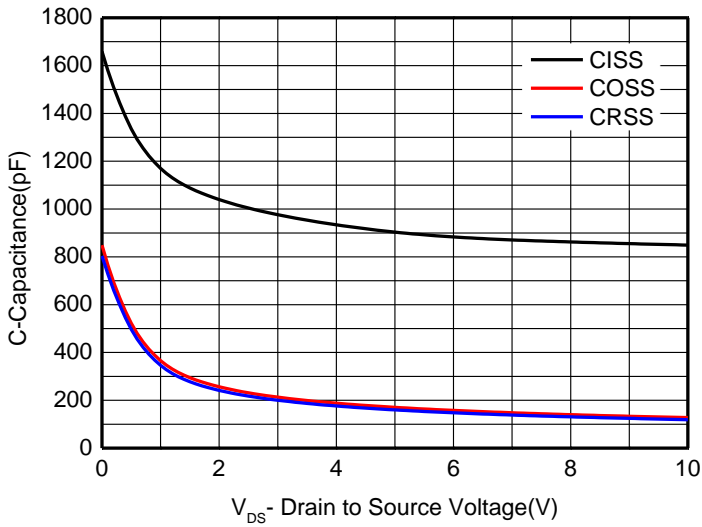
On-Resistance vs. Gate-to-Source voltage



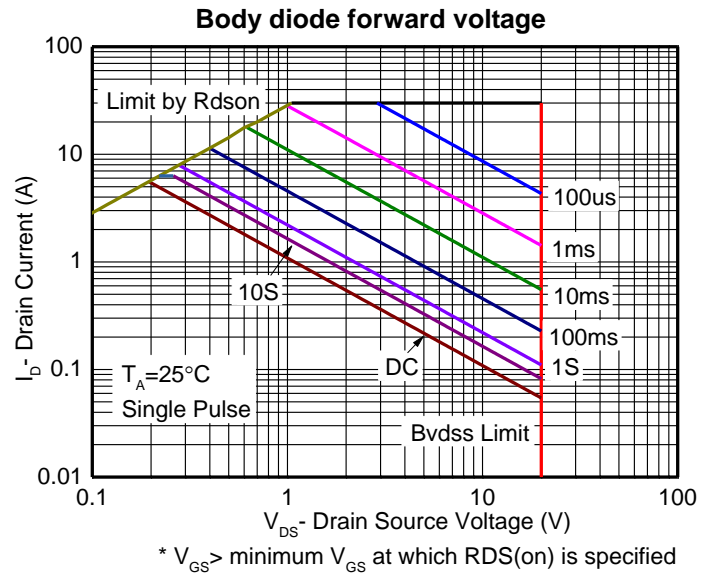
On-Resistance vs. Junction temperature



Threshold voltage vs. Temperature

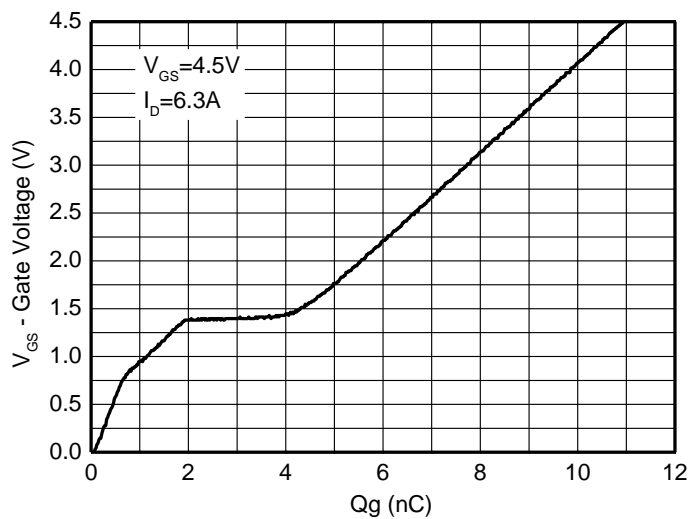


Single pulse power

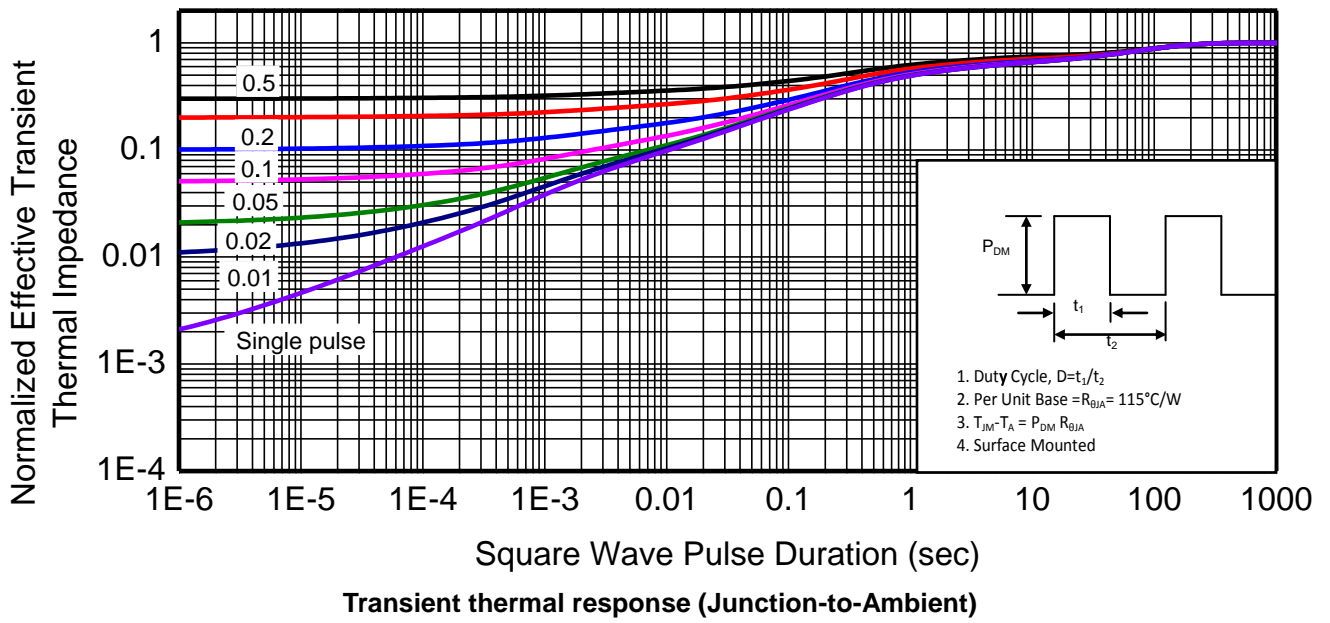


* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

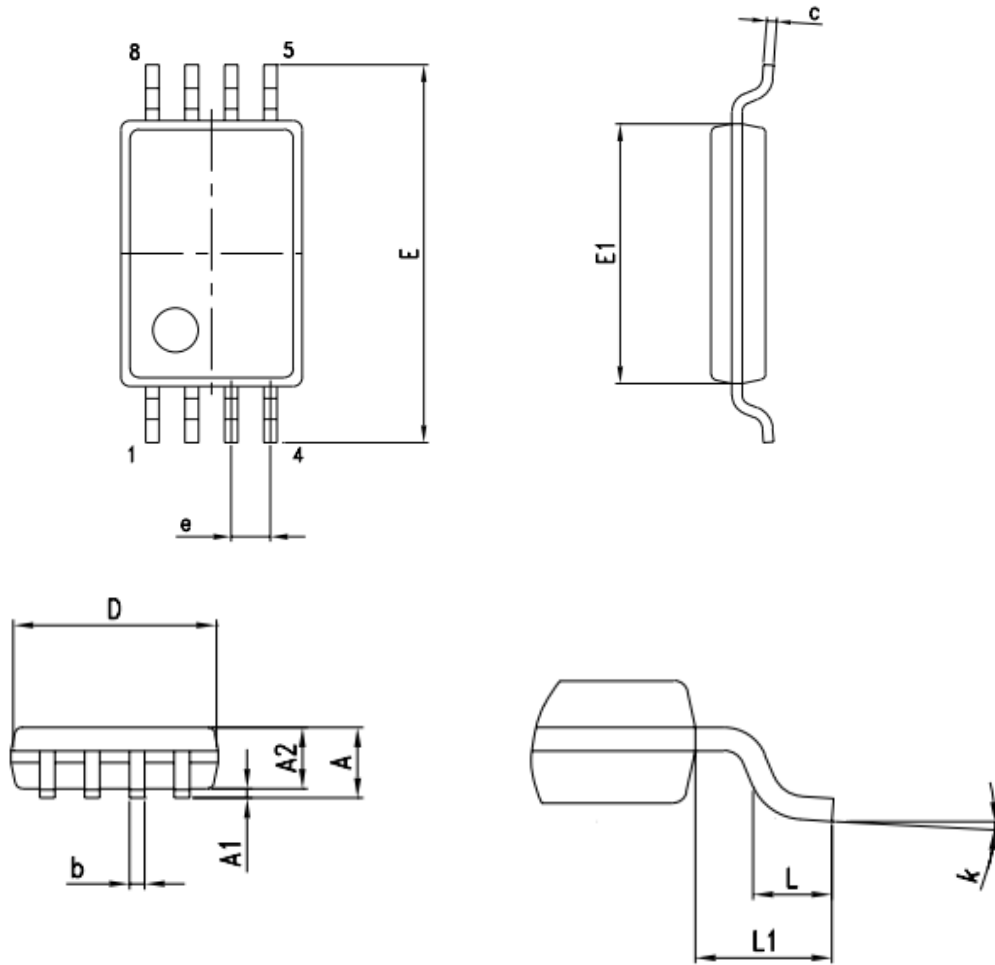
Safe operating power



Gate Charge Characteristics



Package Outline Dimensions : TSSOP-8



| DIM. | mm. | | | inch. | | |
|------|-------|------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 1.05 | | 1.20 | 0.041 | | 0.047 |
| A1 | 0.05 | | 0.15 | 0.002 | | 0.006 |
| A2 | 0.80 | | 1.05 | 0.032 | | 0.041 |
| b | 0.19 | | 0.30 | 0.008 | | 0.012 |
| c | 0.090 | | 0.20 | 0.003 | | 0.007 |
| D | 2.90 | | 3.10 | 0.114 | | 0.122 |
| E | 6.20 | | 6.60 | 0.240 | | 0.260 |
| E1 | 4.30 | | 4.50 | 0.170 | | 0.177 |
| e | | 0.65 | | | 0.025 | |
| L | 0.45 | | 0.75 | 0.018 | | 0.030 |
| L1 | | 1.00 | | | 0.039 | |
| k | 0° | | 8° | 0.192 | | 0.208 |

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